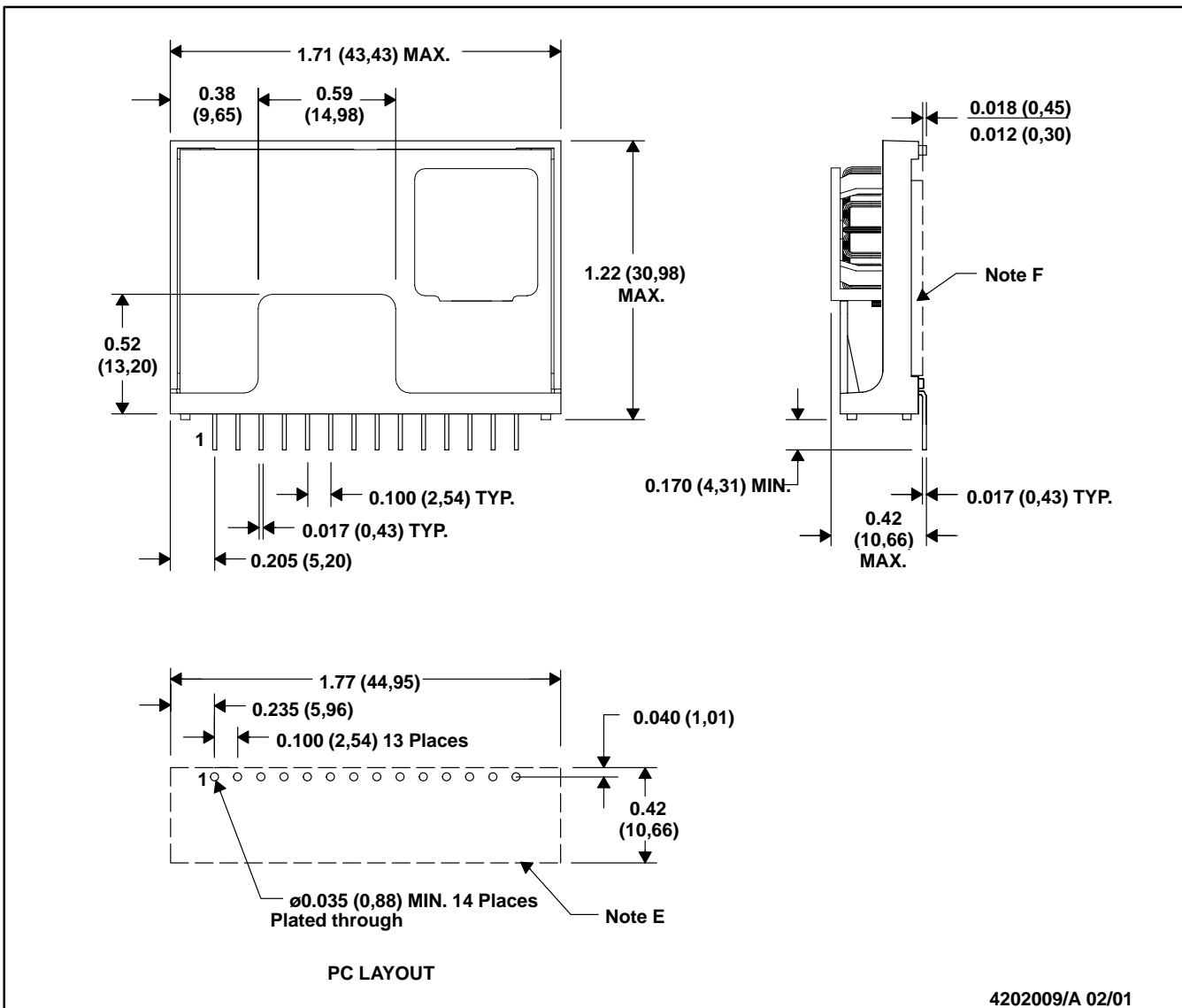


EED (R-PSIP-T14)

PLASTIC SINGLE-IN-LINE MODULE



- NOTES:
- A. All linear dimensions are in inches (mm).
 - B. This drawing is subject to change without notice.
 - C. 2-place decimals are ± 0.030 ($\pm 0,76$ mm).
 - D. 3-place decimals are ± 0.010 ($\pm 0,25$ mm).
 - E. Recommended mechanical keep-out area.
 - F. P-suffix parts include a metal heat spreader. The heat spreader is isolated but electrically conductive, it can be grounded.
 - N-suffix does not include a metal heat spreader.

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